An investigation progress toward Be-based ablator materials for the inertial confinement fusion

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Abstract

The Be-based materials with many particular properties lead to an important research subject. The investigation progresses in the fabrication technologies are introduced here, including main three kinds of Be-based materials, such as Be-Cu capsule, Be₂C ablator and high-purity Be material. Compared with the pioneer workgroup on Be-based materials, the differences in Be-Cu target fabrication were described, and a grain refinement technique by an active hydrogen reaction for Be coating was proposed uniquely. Be₂C coatings were first prepared by the DC reactive magnetron sputtering with a high deposition rate (\sim 300 nm/h). Pure polycrystalline Be₂C films with uniform microstructures, smooth surface, high density (\sim 2.2 g · cm³) and good optical transparency were fabricated. In addition, the high-purity Be materials with metal impurities in a ppm magnitude were fabricated by the pyrolysis of organometallic Be.

Keywords: Be-based materials; Be-Cu capsule; Be₂C ablator; high purity

1. Introduction

Some properties of Be-based materials, such as nucleus property, physics property and ablation property cannot be substituted by any other metal materials^[1–12]. In comparison to the conventional CH ablator, Be-based materials are the best inertial confinement fusion (ICF) ablator due to their low x-ray opacity, high density, high thermal conductivity, as well as having the highest mass ablation rate at every temperature and providing more ablative stabilization^[1-4]. The lower opacity allows the x-rays to penetrate deeper into the Be shell and absorb more energy. The higher density allows more ablative material for a given shell. The higher thermal conductivity is advantageous of the temperature uniformity and forming the symmetrical DT ice layer. In addition, the higher ablation velocities allow implosion of more fuel, and the ablative stabilization reduces the effect of hydrodynamic instabilities during implosion^[4]. As for the promising ignition targets, Be-Cu, Be₂C and high-purity Be materials have aroused special research interest in the field of ICF^[7, 8].

As for one Be-based material, Be-Cu capsule, has been studied by the workgroups of Lawrence Livermore National Laboratory (LLNL), Los Alamos National Laboratory

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(LANL) and General Atomics (GA). The investigation contents mainly focus on the grain size, microstructure homogeneity, thickness uniformity, surface defect, surface smoothness, density, root-mean-square (RMS) surface roughness, stepwise dopant, as well as capsule metrology and characterization^[9–11]. During the Be-based coating growth, the Be atoms array in the form of hexagonal-close-packed (hcp) structure, and the crystal grains grow along c-axis orientation. The Be coatings are mainly characterized by a coarsening columnar grain, and display a strong anisotropy characteristics^[12–15]. These disadvantages weaken the mechanical property and affect ablation characteristics for Be-based materials; thus, a grain refinement method should be developed.

As for another Be-based material, Be₂C ablator, is considered as an excellent potential target ablator because it combines the advantages of both hydrocarbon and Be, and achieves a more balanced ablation performance [16, 17]. It owns the lower atomic number (Z=4.7), and the higher density ($\rho=2.4~\rm g/cm^3$) and mechanical strength than many hydrocarbons [18, 19]. Xie *et al.* prepared Be₂C films for the first time by plasma polymerization of diethyl-beryllium. However, it was difficult to control the ratio of Be to C. Meantime, Shih *et al.* developed radio frequency (RF) reactive magnetron sputtering for depositing Be₂C coatings, which has a low deposition rate (<56 nm/h). These shortcomings limited the development of Be₂C

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coating fabrication^[17, 20–23]. Lately, DC reactive magnetron sputtering was adopted and provided a new promising method to prepare Be₂C coatings^[24].

As a Be material, especially a high-purity Be, it is indispensable for a raw material during the fabrication of Bebased materials. In the design of Be-based materials, the impurity contained is inversely proportional to the square of atomic number $(Z)^{[25, 26]}$ because of being sensitive to the implosion process. The larger the Z is, the lower the impurity is. Usually, the impurity in Be materials is mainly O, C, Fe, Al, Si, etc, which is associated with the Be ore compositions. The S-65C Be materials with a purity of 99.54 wt.% was first produced by Brush Wellman in 1997^[27], and the main impurity included 0.6% BeO, 0.012% C, 620 ppm Fe, 185 ppm Al, 160 ppm Si and 130 ppm Ni. Subsequently, the Materion Corporation (previous Brush Wellman) announced the ultrahigh purity Be material with 99.99% in 2011. It is very regretful that the Be purification technique, in particular ultrahigh purity Be, is scarcely reported because of technique secrecy. Although some research institutions reported that they successfully purified Be via some technology^[28, 29], such as vacuum distillation, zone melting, electrotransport processing and so on, they did not give the experimental details, impurity compositions and level.

The objective of this paper is to introduce the fabrication technology of Be-based materials, including Be-Cu capsule, Be₂C ablator and high-purity Be material, as well as their research progresses, and then analyze the difference between ours and pioneer workgroup's. In addition, a new grain refinement way by an active hydrogen reaction for strong anisotropic Be coating, an effective deposition method for preparing uniform Be₂C coatings with a smooth surface, and a pyrolytic technology for Be material purification have been reported here.

2. Be-Cu capsule

2.1. Preparation principle of Be-Cu capsule

There are two kinds of technologies to fabricate the Be-Cu capsule, the physical vapor deposition (PVD) and chemical vapor deposition (CVD). At present, the main technology is the magnetron sputtering, which belongs to PVD methods. The magnetron can generate plasma by the glow discharge on its surface. The ionized gas atoms (in our case Ar) are accelerated by an electric field, and then collide with a target material of sputtering source. Be atoms or Cu atoms would be ejected from the target surface and deposit onto the substrate to form the coating. For a Be-Cu capsule fabrication, the substrate requires a spherical mandrel, such as poly(alpha-methylstyrene) (PAMS), Si, Ni and Fe, as a template onto which the metal is deposited. In order to improve the thickness uniformity, a bounce pan needs to

be used, which is to provide a nearly random motion. The bounce pan is usually agitated by the knock, rotating, shake, as well as their combination mode during the coating.

There are many advantages for magnetron sputtering technique to fabricate the Be capsule. First, the target material can be fixed at arbitrary directions. The particle beam flux is from up to down, which is convenient to fabricate the Be capsule coupling the bounce pan. Second, there is small substrate thermal effect. When the sputtering power is lower than 120 W, the substrate temperature is less than 120 °C in our experiment. Accordingly, the plastic mandrels can be easy for selection, which is favorable to pyrolytic removal in the latter. Third, the incident particle energy during sputtering is about several to tens of electron volts, and the coating has a high density.

2.2. Dopant rule in Be capsule

The Be capsule used as ablator and DT fuel container usually needs to dope other element, which mostly is doped middle Z. Its aim is to adjust the opacity, which keep x-ray flux and suprathermal electrons from preheating the inner DT ice layer, and ensure the hot spot with a low entropy compress before implosion. Moreover, the graded Cu-doped Be has less sensitivity to perturbations, which helps to reduce Rayleigh–Taylor instability during implosion^[11, 19, 26, 30]. Due to the small Be atom radius, most elements are fully immiscible with Be each other. The doped elements in Be need to consider its solid solubility. According to the binary alloy phase diagrams^[31], there exist only four species (Z < 50), such as Co, Ni, Cu and Pd, that solid solubility is larger than 1%. The solid solubility of Cu in Be, 9.5 at.%, is the largest than other. Therefore, the Cu element is first selected as dopant in Be for the National Ignition Facility (NIF) targets design, which can leave more margins to upgrade target. Previously, the Cu dopant concentration in Be is designed as 0.7 at.% in Rev $0^{[30,32]}$, while the level of Cu dopant in Rev 6 Be-Cu capsule designed by Wilson et al. [1, 2] has increased to 3.0 at.%. Obviously, the target development would be limited if other elements were selected.

2.3. Progress on Be-Cu capsule

The Cu-doped Be capsules were prepared by DC magnetron sputtering using the separate Cu and Be sources onto about 1.2 mm diameter PAMS spherical mandrels. Four round magnetrons were equipped with a Be target of 76.2 mm in diameter, fixed symmetrically around the center of the chamber, where one 50.8 mm Cu magnetron sputter source was positioned. The magnetrons point down toward a bounce pan that holds the samples. The base pressure was typically 2×10^{-6} Pa, and the sputtering pressure is in 0.1–1.0 Pa Ar environment. The distance between the substrate

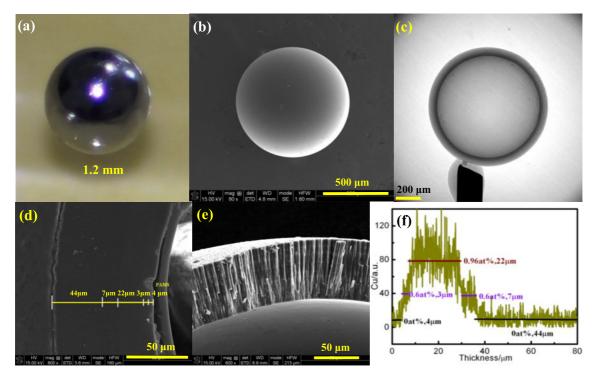


Figure 1. Be—Cu capsule. (a) Optical microscope image, (b) SEM image, (c) micro-CT image, (d) polished cross-section morphology, (e) cross-section morphology, (f) Cu dopant distribution at cross-section.

and Be target is 90 mm, which is not in good agreement with the Cu target to substrate distance of 300 mm. The four Be guns are operated at the range of 60–120 W, while one Cu gun is at 10–30 W. The coating rates are 0.3–0.42 μ m/h at the situation.

The specifications of Be–Cu capsule prepared by the sputtering method in our experiment: the capsule diameter is 1.2 mm, RMS roughness 85 nm, average deviation of wall thickness $\pm 1.5~\mu m$, the Cu dopant in the concentration range of 0.6 at.%–0.96 at.%, starting from the inside of Be shell, the thickness for each shell layer is 4, 3, 22, 7 and 44 μm , while the Cu is distributed as 0, 0.6 at.%, 0.96 at.%, 0.6 at.% and 0, as shown in Figure 1. Further, the impurity and composition is detected by the inductively coupled plasmamass spectrometry (ICP-MS) method, including 0.003 at.% Al, 0.04 at.% Si, 0.025 at.% Mn, 0.97 at.% Fe and 0.058 at.% Ni. Both O and C elements are quantitatively analyzed by energy dispersive x-ray spectrometer (EDS) at 1.3 at.% and 4.5 at.%, respectively.

Figure 1(a) presents the optical microscope images of Be—Cu capsule with 1.2 mm diameter, and the polished capsule surface looks smooth and glistening. Figure 1(b) reveals the scanning electron microscope (SEM) image of Be—Cu capsule. Figure 1(c) gives the micro-computed tomography (CT) image of Be—Cu capsule. The shell thickness can be clearly observed and the difference of gray value along radial direction indicates the dopant level change. Figure 1(d) gives the polished cross-section of Be—Cu capsule, and each dopant shell layer can be basically distinguished. Figure 1(e)

gives the cross-section microstructure of Be–Cu capsule, which is characterized by the columnar grain. Figure 1(f) gives the EDS pattern and the Cu distribution along the radial direction, which is quantitatively determined via the ICP-MS scaling.

In order to further compare and analyze, the Rev 5 specifications for Be–Cu capsule [26] designed and fabricated by the LLNL workgroup are given. The Be–Cu capsules are made of inner and outer layers of pure Be with three thin intermediate layers of Be with a Cu dopant. The capsule diameter is 2.36 mm, wall thickness deviation $\pm 1.5~\mu m$, RMS roughness 20 nm, the Cu dopant in Be, the concentration deviation ± 0.1 at.%. Starting from the inside of Be shell, the thickness for each shell layer is 5, 4, 23, 8 and 118 μm , respectively. Be impurities can be controlled at O < 0.4 at.%, Ar < 0.25 at.%, C < 0.005 at.%, Al < 0.01 at.%, Si < 0.005 at.%, Mn < 0.00015 at.%, Fe < 0.005 at.% and Ni < 0.001 at.%.

Some differences on the fabrication technique of Be–Cu capsule still exist between LLNL workgroup and ours. First, our Be capsule has a small diameter of 1.2 mm, which is limited by the mandrel preparation technology. The PAMS mandrels with ~ 2.0 mm diameter cannot be produced at present. Second, the surface roughness of Be–Cu capsule cannot still arrive at 20 nm, and the capsule polishing technology needs to be further studied. Third, the impurity elements listed in Rev 5 were also detected and they had high concentrations in Be–Cu capsule, especially O.

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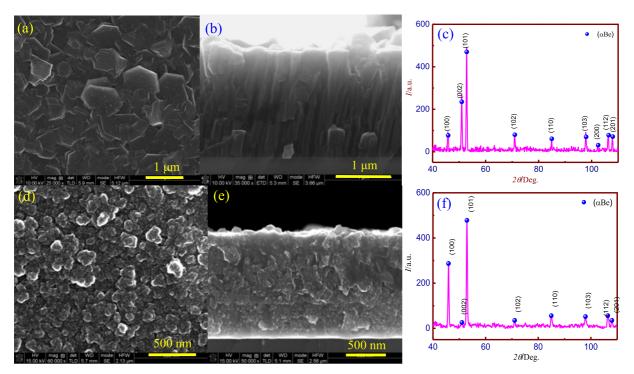


Figure 2. Be coating morphologies. (a), (b) and (c) surface microstructure, cross-section microstructure and XRD pattern of Be coating prepared by thermal evaporation, (d), (e) and (f) surface microstructure, cross-section microstructure and XRD pattern of Be coating prepared by reactive evaporation.

The main reason is that the purity of Be targets is low, about 99 at.%. A high-purity Be target, which is difficult to fabricate and purchase, needs to be used during sputtering. Fourth, the target fabrication technology is still imperfect, and the investigation on drill hole and mandrel pyrolysis still remains to be done.

2.4. Progress on Be grain refinement

The Be capsule fabricated by anyone or any method is always characterized by a columnar grain with large diameter [33–37], which is relevant closely to a hcp structure of Be. The lattice constant, a=0.2286 nm, c=0.3584 nm, and the ratio c to a is 1.568, which is the lowest in all metals with hcp structure. Thus, the Be film is easy to grow along a preferential orientation and displays a strong anisotropy. The columnar grain reduces the Be capsule performance in the yield strength, fuel retention and ablation velocity, which is restricted in its development and application in the field of ICF. The nanocrystalline Be capsule can improve these capsule performances, which has aroused great research interest.

The Be coating is prepared by a reactive evaporation method^[38, 39]. After a Be coating is deposited by a thermal evaporation and achieves a thickness, the H₂ ionization source by RF fluxes into the vacuum chamber during the evaporation, which mixes into the Be atom beam and produces the BeH₂. The amorphous BeH₂ can interrupt the growth of Be columnar grain and achieves the Be

grain refinement. The base pressure of reactive evaporation equipment was typically 5×10^{-6} Pa, and the distance of source to substrate is about 150 mm. One condition of Be coating fabrication is the evaporation temperature of $1100\,^{\circ}$ C, the deposition time of 40 min, and the deposition rate of 5.5 nm/min. Another condition of BeH₂ coating fabrication is the evaporation temperature of $1100\,^{\circ}$ C, the RF power of 200 W, the reflected power less than 20 W, the H₂ gas flow of 20 sccm, work pressure of 0.25 Pa, deposition time of 5 min, and the deposition rate of 1.7 nm/min. Both conditions are alternant to be carried out, and the experimental results are plotted in Figure 2.

Figures 2(a), (b) and (c) show the surface microstructure, cross-section microstructure and x-ray diffraction (XRD) pattern of Be coating prepared by thermal evaporation. The Be coating is characterized by a hexagonal sheet grain with an average diameter of 510 nm, while the cross-section microstructure displays the parallel columnar grain each other. Figures 2(d), (e) and (f) show the surface microstructure, cross-section microstructure and XRD pattern of Be coating prepared by reactive evaporation. Although the Be coating consists of a $(\alpha$ -Be) phase, the growth morphologies are different each other. Here, the surface morphology looks very similar to the cross-section morphology comprised by the fine grain with an average diameter of 45 nm. The Be columnar grain in the cross-section is interrupted by the chemical reaction of an active hydrogen with Be atom, and the produced amorphous BeH2 film with a few nanometer thickness can interrupt the Be columnar grain

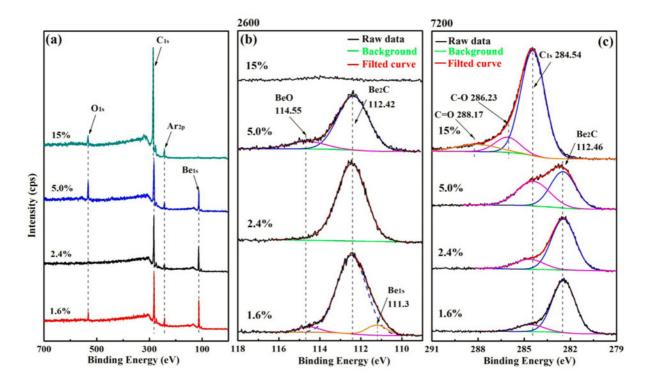


Figure 3. XPS spectra for films prepared at different CH_4 -Ar ratios after 30 min Ar^+ etching survey spectrum (a), deconvolution of Be1s peaks (b) and deconvolution of C1s peaks (c).

growth. At present, the investigation on grain refinement of Be coating is still scarce, and has a little effect. The active hydrogen reaction method can offer new prospects to achieve the grain refinement for Be coating.

3. Be₂C ablators

3.1. Fabrication principle of Be₂C

Be₂C ablators were prepared by DC reactive magnetron sputtering of Be target under argon—methane mixture plasma^[24]. Argon and methane are ionized by the glow discharge. Then, Ar ions were accelerated by high voltage electric field and impinged the target surface. The sputtered target atoms react with the ionized reaction gas (CH₃⁺, CH₂²⁺, etc) and deposit onto the substrate to form thin films. Evidently, the target surface atoms also react with the ionized gases and form a compound layer, which will result in the target poisoning. During the sputtering, the poisoning effect can be controlled by optimizing the sputtering chamber and the reactive gas influx mode^[24].

3.2. Progress on Be₂C ablators

In the present work, first, the process conditions were optimized to obtain pure polycrystalline Be_2C films. Second, the properties of Be_2C films were characterized to confirm its outstanding performance related to ICF application.

3.2.1. Be₂C composition and crystallinity optimization

Figure 3 shows the variation of composition as a function of the CH₄-Ar ratio, as given by x-ray photoelectron spectroscopy (XPS) spectrum. It is found that the Be content decreases, while the C content increases gradually with the increasing CH₄-Ar ratios. The pure hydrocarbon films will be formed when the CH₄-Ar ratio exceeds the critical value. Similarly, the Be content in the films increases with the increase of sputtering power (not shown). Co-regulation of flow ratio and sputtering power is necessary for the preparation of pure Be₂C films. The purest Be₂C films have been obtained when the CH₄-Ar ratio is 10% and sputtering power maintains at 150 W.

Figures 4(a) and (b) give the typical high-resolution transmission electron microscope (TEM) image of Be₂C film deposited at room temperature and typical XRD pattern of film grown at 600 °C, respectively. Be₂C films without *in situ* annealing exhibit a nanocrystalline composite structure and cannot be detected by XRD. Films grown at high temperature show obvious diffraction peaks similar to the standard Be₂C powder diffraction card (PDF-33-0191)^[40], which indicate the films are mainly composed of polycrystalline particles without preferential orientation.

Thus, it can be concluded that: in the reactive sputtering process, the flow ratios and sputtering power mainly affect the compositions, and the substrate temperature influenced the crystallinity of the Be₂C films.

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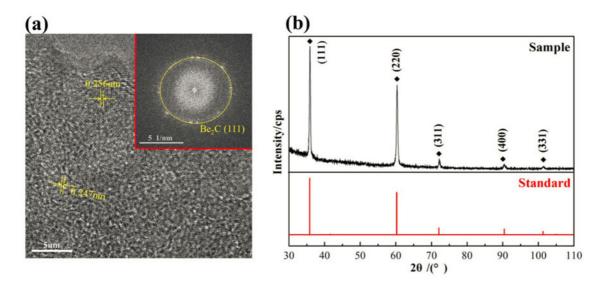


Figure 4. (a) High-resolution TEM image and corresponding FFT pattern (inset upper right) for film deposited at room temperature, (b) typical XRD pattern of films with *in situ* annealing.

3.2.2. Property characterization

One of the key factors for the ICF target is the surface finish, which usually gets worser as the thickness of the Be films increases. Thus, the relation between the surface finish and film thickness is critical for ICF applications, and needs to be investigated.

The influence of thickness on morphologies and roughness in Be₂C film was studied by SEM and atomic force microscope (AFM). Figures 5(a) and (b) show the surface morphologies of films with thickness of 530 and 2300 nm, respectively. Both of them exhibit very similar morphology that many small spherical-shaped granules homogeneously distribute over the surfaces. The corresponding surface roughnesses (RMS) for films with thickness of 530 and 2300 nm are 2.63 and 3.23 nm, respectively. Similar surface morphology and roughness indicate that the surface finish of Be₂C films is not sensitive to the thickness. Figures 5(a1) and (b1) are the cross-sectional morphologies of Be₂C films measured by SEM. The cross-sectional morphologies reveal the uniform microstructure (without columnar crystal) of Be₂C films, which is conducive to improving the symmetry of the ablation in ICF.

Based on the mass gain and thickness measured by SEM, the density and deposition rate of Be₂C coatings were studied. The results revealed: the density of the deposited coatings reached \sim 2.2 g/cm³, which fully embodied the high density advantages of Be₂C coatings with respect to beryllium and hydrocarbons; the deposition rate of DC reactive magnetron sputtering reached \sim 300 nm/h, which showed the obvious advantage over RF sputtering (<56 nm/h)^[22].

As ICF capsule materials, optical transparency is another advantage of Be₂C over Be coatings. Figure 6 shows the typical optical transmittance spectra of the Be₂C films and

corresponding photograph. It reveals that Be₂C coatings are transparent yellow-brown with sufficient (\sim 40%) transmittance in the visible region and higher transmittance in the near infrared region (80%). The optical transparent properties of Be₂C make it possible to characterize the DT layers in Be₂C capsules by optical methods and homogenized by infrared heating.

4. High-purity Be materials

4.1. Purification principle

Most purification methods separate the impurity by some difference of physical or chemical property between metal and impurity, such as the saturated vapor pressure, evaporation rate, melting point, as well as solubility difference between liquid phase and solid phase. Here, the pyrolysis method of the organometallic Be is used to generate the high-purity Be materials^[41]. At first, the Be raw material (98.5 wt%) is chloridized to produce the BeCl₂. Afterward, the BeCl₂·2Et₂O reacts with the t-butyl Grignard reagent to produce di-t-butylberyllium etherate, whose purity can reach at 99.999 wt% by the distillation. Finally, the high-purity di-t-butylberyllium etherate (provided by Nanjing University) is pyrolyzed to form high-purity Be.

4.2. Progress on high-purity Be materials

The high-purity Be powder was prepared by the pyrolysis method. Figure 7 shows the SEM image of the compressed Be powder. The powder particle looks nearly spherical from SEM images, and its average diameter is about $1 \mu m$.

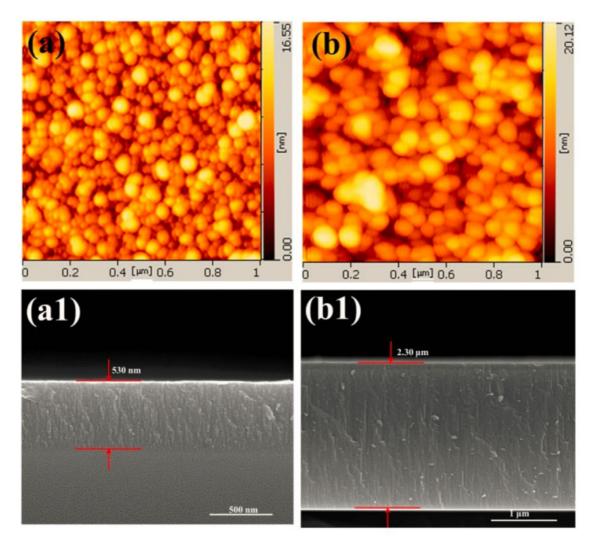


Figure 5. Typical surface and cross-sectional morphologies of Be₂C films with different thickness: (a) and (b) surface morphologies by AFM, (a1) and (b1) cross-sectional morphologies by SEM.

The chemical compositions and impurity level in Be block were determined by a high-resolution ICP-MS (ppb) and ICP atomic emission spectrometry (AES) (ppm) after the sample was chemically digested with high-purity water and high-purity acid. The ultimate analysis results are needed to subtract the background value from the blank experiment, which was a complete ICP characterization except for adding Be powder into acids. In an ICP guide determination, the whole spectrum of Be powder was scanned first, and then nine impurities were quantitatively determined. Table 1 lists the content of Al, Fe, Mn, Ni, Cr, Ga, Co, Mo, Sb, O and C, etc.

The total content of the nine metal impurities is 61 ppm, and mainly includes the two major impurities, the Al of 34.7 ppm and Fe of 23.8 ppm. In the process of Be purification, the dodecane was only used as a solvent. The impurity in the solvent was also determined by ICP-MS and ICP-AES. The results show that there exists no impurity in

Table 1. The content of impurities in Be powder.

Impurities	Content	Characterization methods
Al	34.7 ppm	ICP-AES
Fe	23.8 ppm	ICP-AES
Mn	0.045 ppm	ICP-MS
Ni	0.33 ppm	ICP-MS
Cr	0.9 ppm	ICP-MS
Ga	0.25 ppm	ICP-MS
Co	0.41 ppm	ICP-MS
Mo	0.32 ppm	ICP-MS
Sb	0.048 ppm	ICP-MS
0	0.82 at.%	LECO
C	2.22 at.%	LECO

the dodecane. It can be plausibly deduced that the impurities in the Be powder are mostly from the raw materials of di-t-butylberyllium etherate. Both C and O contents are 8 B. C. Luo et al.

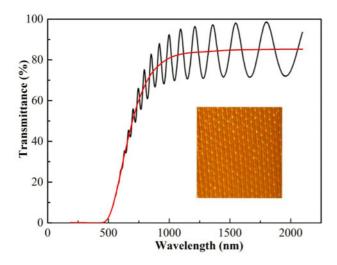


Figure 6. Typical optical transmittance spectra of the Be₂C films and corresponding photograph (inset).

determined by LECO. There is a high content for C and O, 0.82 at.% O and 2.22 at.% C. The C results from the alkylberyllium produced by incomplete pyrolysis of dit-butylberyllium etherate, and its content depends on the pyrolysis temperature^[40]. The O in the Be powder is attributed to oxidation upon exposure of the Be powder in air during the storage and measurement.

5. Conclusions

The Be-based materials, such as Be-Cu capsule, Be₂C, and high-purity Be material, have been investigated. The Be-Cu capsule with 1.2 mm diameter, RMS roughness 85 nm, average deviation of wall thickness $\pm 1.5 \,\mu m$, the Cu dopant in the concentration range of 0.6 at.%-0.96 at.% and total shell thickness of 80 µm has been fabricated. For strong anisotropic Be coating, a new active hydrogen reaction method can refine the Be grain size to 45 nm. Be₂C films were first deposited by DC reactive sputtering with a high deposition rate of 300 nm h^{-1} . The compositions of the films mainly affected by the CH₄-Ar ratios and sputtering power, and substrate temperature influenced the crystallinity. The properties of the pure polycrystalline Be₂C films were characterized, which showed uniform microstructure, smooth surface, high density and good optical transparency. In addition, a particular purification technology for Be materials by pyrolysis of di-t-butylberyllium etherate has been reported in our work. The total content of metal impurities was 61 ppm by ICP-MS determination, including the two major impurities, the Al of 34.7 ppm and Fe of 23.8 ppm. The total C and O contents determined by LECO were 2.22 at.% and 0.82 at.%, respectively.

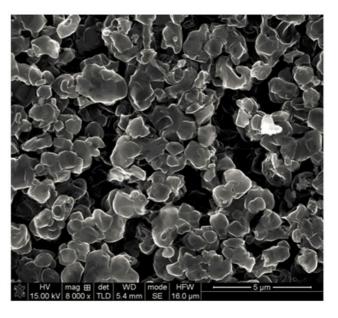


Figure 7. SEM micrograph of compressed Be powders.

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